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<u>MOSFET</u> – Power, Single N-Channel, DFN5/DFNW5 60 V, 2.4 mΩ, 150 A

NVMFS5C628NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C628NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS	$(T_{\rm J} = 25^{\circ})$	C unless otherw	vise noted)		
Parar	neter		Symbol	Value	Unit
Drain-to-Source Voltag	Drain-to-Source Voltage		V _{DSS}	60	V
Gate-to-Source Voltage	Gate-to-Source Voltage		V _{GS}	±20	V
Continuous Drain		$T_{C} = 25^{\circ}C$	۱ _D	150	А
Current $R_{\theta JC}$ (Notes 1, 3)	Steady	T _C = 100°C		110	
Power Dissipation	State	T _C = 25°C	PD	110	W
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$		56	
Continuous Drain		$T_A = 25^{\circ}C$	I _D	28	А
Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C		20	
Power Dissipation	State	T _A = 25°C	PD	3.7	W
$R_{\theta JA}$ (Notes 1 & 2)		$T_A = 100^{\circ}C$		1.9	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	А
Operating Junction and Storage Temperature		T _J , T _{stg}	–55 to + 175	°C	
Source Current (Body Diode)		ا _S	120	А	
Single Pulse Drain-to-Source Avalanche Energy $(I_{L(pk)} = 9 A)$		E _{AS}	565	mJ	
Lead Temperature for S (1/8" from case for 10 s		Purposes	ΤL	260	°C

MAXIMUM RATINGS (T = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

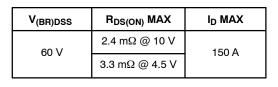
THERMAL RESISTANCE MAXIMUM RATINGS

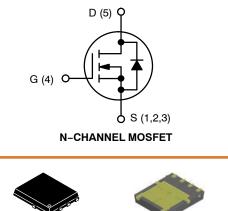
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	R _{θJA}	40	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

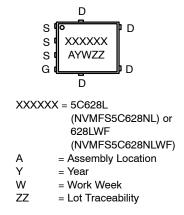




DFN5 (SO-8FL) CASE 488AA

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA

MARKING DIAGRAM



ORDERING INFORMATION

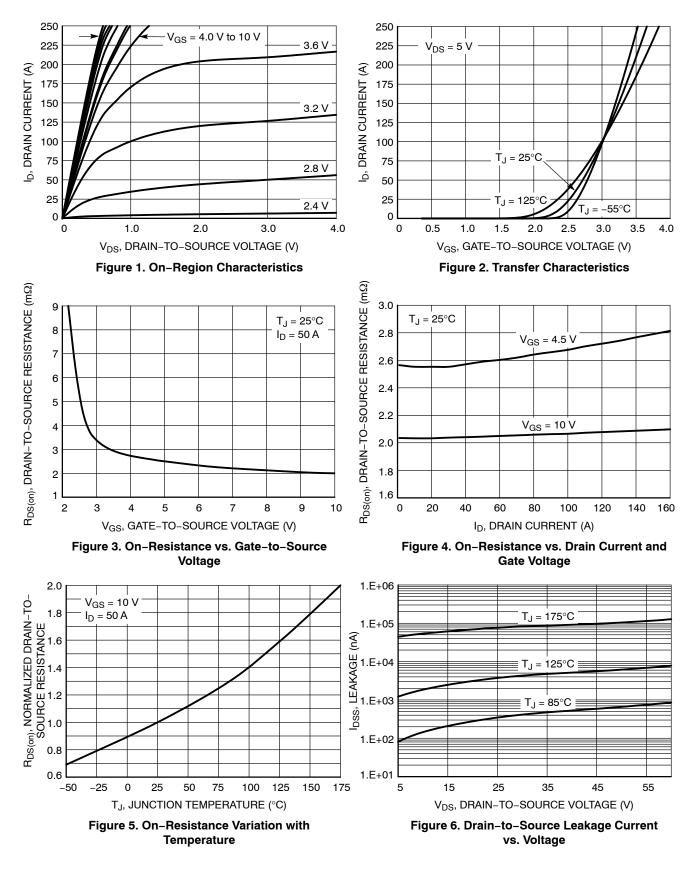
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

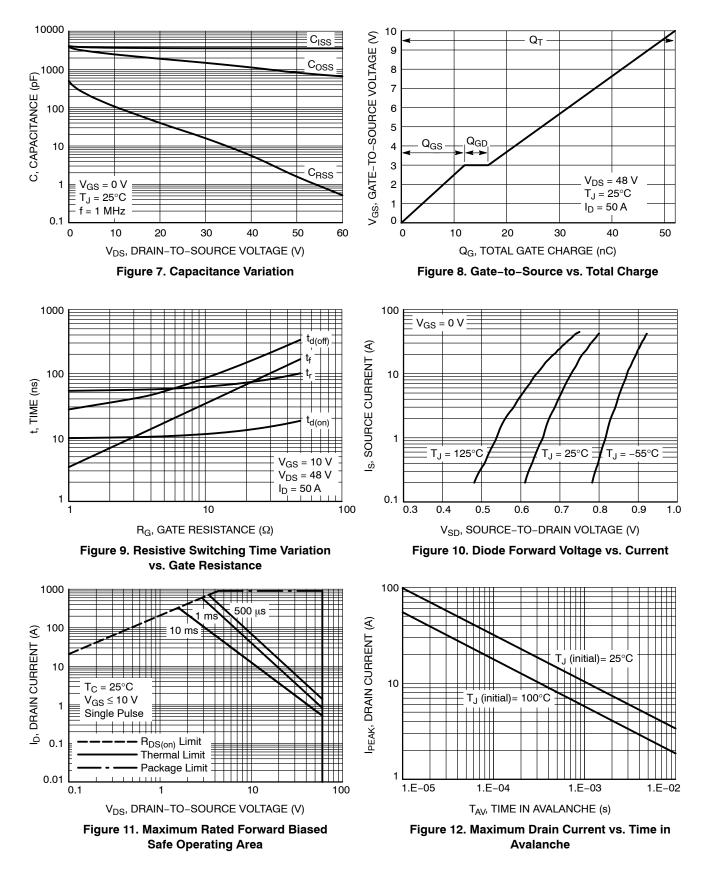
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D =	= 250 μA	60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				26		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			10	
		V _{DS} = 60 V	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 135 μ A		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		2.0	2.4	-
		V _{GS} = 4.5 V	I _D = 50 A		2.6	3.3	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D) = 50 A		110		S
CHARGES AND CAPACITANCES	-				•		
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			3600		pF
Output Capacitance	C _{OSS}				1700		
Reverse Transfer Capacitance	C _{RSS}				28		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 50 A			24		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 50 A			52		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 50 A			6.0		nC
Gate-to-Source Charge	Q _{GS}				12		
Gate-to-Drain Charge	Q _{GD}				4.5		
Plateau Voltage	V _{GP}				3.0		V
SWITCHING CHARACTERISTICS (Note 5)					1	1
Turn-On Delay Time	t _{d(ON)}				10		
Rise Time	t _r	V_{GS} = 10 V, V_{DS} = 48 V, I_{D} = 50 A, R_{G} = 2.5 Ω			55		ns
Turn-Off Delay Time	t _{d(OFF)}				37		
Fall Time	t _f				8.5		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C		0.8	1.2	
		$I_{\rm S} = 50 \text{A}$ $T_{\rm J} = 125^{\circ}\text{C}$		0.75		V	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dls/dt = 100 A/µs, I _S = 50 A			55		
Charge Time	ta				28		ns
Discharge Time	t _b				28		
Reverse Recovery Charge	Q _{RR}				60		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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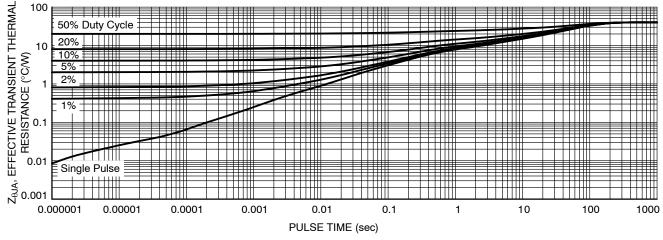


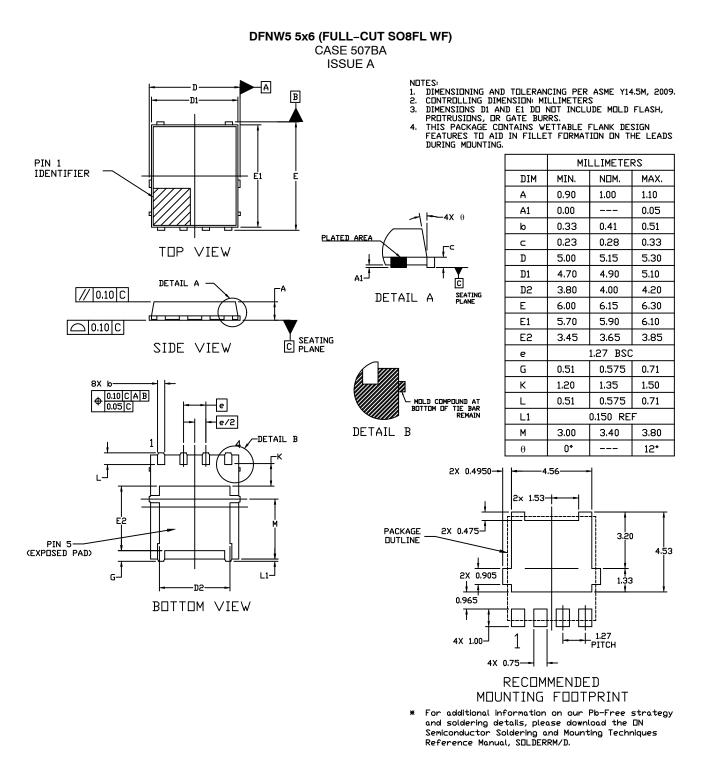
Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]
NVMFS5C628NLT1G	5C628L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C628NLWFT1G	628LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C628NLT3G	5C628L	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS5C628NLWFT3G	628LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C628NLAFT1G	5C628L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C628NLAFT1G-YE	5C628L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C628NLWFAFT1G	628LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

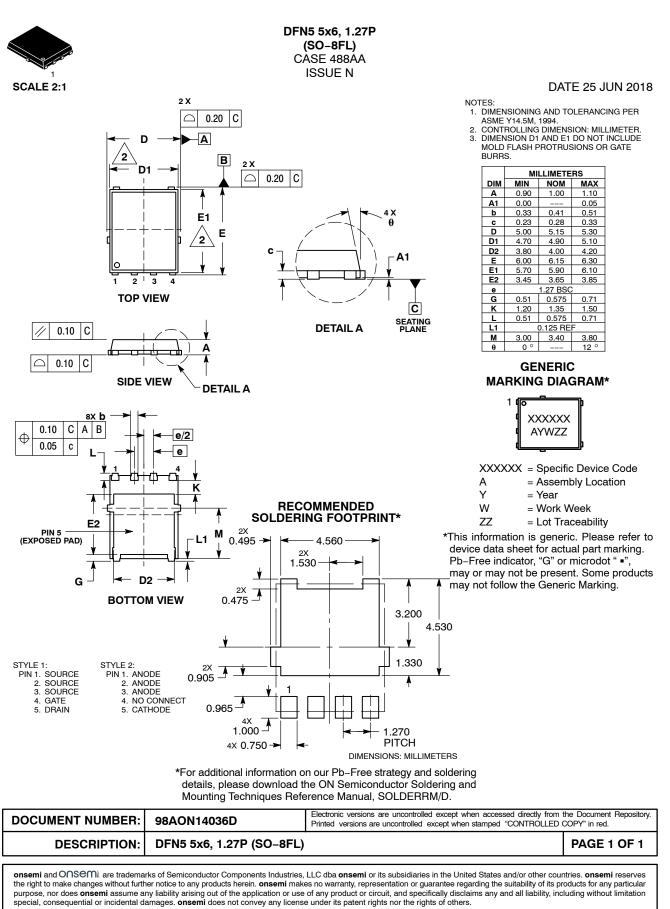
DEVICE ORDERING INFORMATION

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



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